



# PQMD2

NPN/PNP resistor-equipped transistors;  
R1 = 22 k $\Omega$ , R2 = 22 k $\Omega$

4 November 2015

Product data sheet

## 1. General description

NPN/PNP double Resistor-Equipped Transistors (RET) in a leadless ultra small DFN1010B-6 (SOT1216) Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

- 100 mA output current capability
- Built-in bias resistors
- Simplifies circuit design
- Low package height of 0.37 mm
- Reduces component count
- Reduces pick and place costs
- AEC-Q101 qualified

## 3. Applications

- Low current peripheral driver
- Control of IC inputs
- Replaces general-purpose transistors in digital applications
- Mobile applications

## 4. Quick reference data

Table 1. Quick reference data

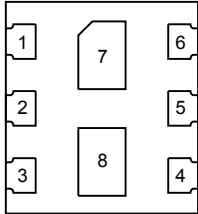
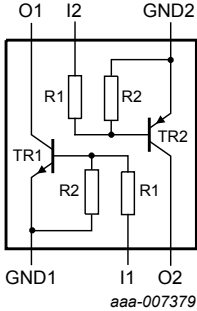
| Symbol   | Parameter                 | Conditions               | Min | Typ  | Max | Unit |            |
|--|---------------------------|--------------------------|-----|------|-----|------|------------|
| <b>Per transistor; for the PNP transistor with negative polarity</b> |                           |                          |     |      |     |      |            |
| V <sub>CEO</sub>   | collector-emitter voltage | open base                | -   | -    | 50  | V    |            |
| I <sub>O</sub>   | output current            |                          | -   | -    | 100 | mA   |            |
| <b>Per transistor; for the PNP transistor with negative polarity</b> |                           |                          |     |      |     |      |            |
| R1   | bias resistor 1           | T <sub>amb</sub> = 25 °C | [1] | 15.4 | 22  | 28.6 | k $\Omega$ |
| R2/R1  | bias resistor ratio       |                          | [1] | 0.8  | 1   | 1.2  |            |

[1] See section "Test information" for resistor calculation and test conditions.

NPN/PNP resistor-equipped transistors; R1 = 22 k $\Omega$ , R2 = 22 k $\Omega$ 

## 5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description            | Simplified outline  | Graphic symbol  |
|-----|--------|------------------------|---|---|
| 1   | GND1   | GND (emitter) TR1      |  <p>Transparent top view<br/><b>DFN1010B-6 (SOT1216)</b></p> |  <p>aaa-007379</p> |
| 2   | I1     | input ( base) TR1      |   |   |
| 3   | O2     | output (collector) TR2 |   |   |
| 4   | GND2   | GND (emitter) TR2      |   |   |
| 5   | I2     | input ( base) TR2      |   |   |
| 6   | O1     | output (collector) TR1 |   |   |
| 7   | O1     | output (collector) TR1 |   |   |
| 8   | O2     | output (collector) TR2 |   |   |

## 6. Ordering information

Table 3. Ordering information

| Type number | Package    |  |         |
|-------------|------------|--|---------|
|             | Name       | Description  | Version |
| PQMD2       | DFN1010B-6 | DFN1010B-6: plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals | SOT1216 |

## 7. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PQMD2       | B 001        |

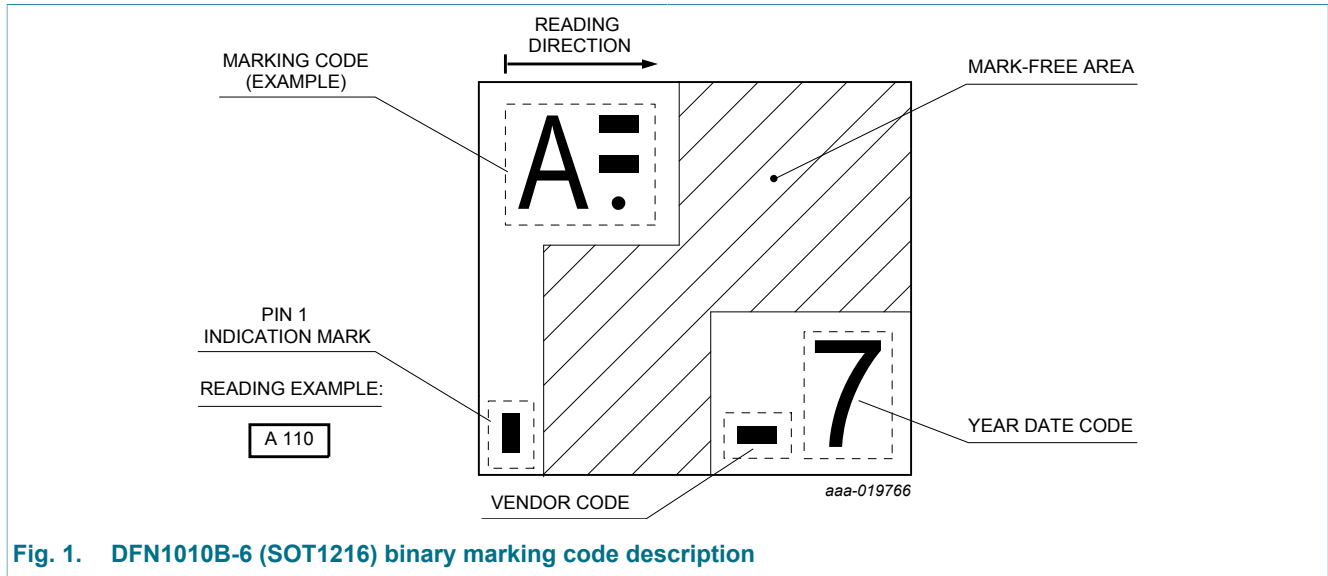


Fig. 1. DFN1010B-6 (SOT1216) binary marking code description

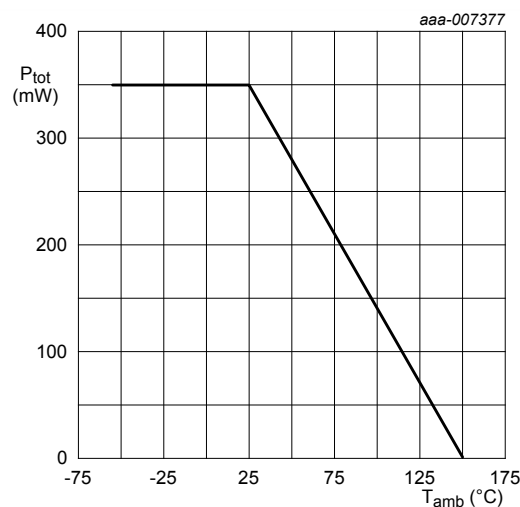
## 8. Limiting values

**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol   | Parameter                 | Conditions                          |     | Min | Max | Unit |
|--|---------------------------|-------------------------------------|-----|-----|-----|------|
| <b>Per transistor; for the PNP transistor with negative polarity</b> |                           |                                     |     |     |     |      |
| V <sub>CBO</sub>   | collector-base voltage    | open emitter                        |     | -   | 50  | V    |
| V <sub>CEO</sub>   | collector-emitter voltage | open base                           |     | -   | 50  | V    |
| V <sub>EBO</sub>   | emitter-base voltage      | open collector                      |     | -   | 10  | V    |
| V <sub>I</sub>   | input voltage             | TR1; positive                       |     | -   | 40  | V    |
|  |                           | TR1; negative                       |     | -   | -10 | V    |
|  |                           | TR2; positive                       |     | -   | 10  | V    |
|  |                           | TR2; negative                       |     | -   | -40 | V    |
| I <sub>O</sub>   | output current            |                                     |     | -   | 100 | mA   |
| I <sub>CM</sub>  | peak collector current    | t <sub>p</sub> ≤ 1 ms; single pulse |     | -   | 100 | mA   |
| P <sub>tot</sub>   | total power dissipation   | T <sub>amb</sub> ≤ 25 °C            | [1] | -   | 230 | mW   |
| <b>Per device</b>  |                           |                                     |     |     |     |      |
| P <sub>tot</sub>   | total power dissipation   | T <sub>amb</sub> ≤ 25 °C            | [1] | -   | 350 | mW   |
| T <sub>j</sub>   | junction temperature      |                                     |     | -   | 150 | °C   |
| T <sub>amb</sub>   | ambient temperature       |                                     |     | -55 | 150 | °C   |
| T <sub>stg</sub>   | storage temperature       |                                     |     | -65 | 150 | °C   |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



FR4 PCB, standard footprint

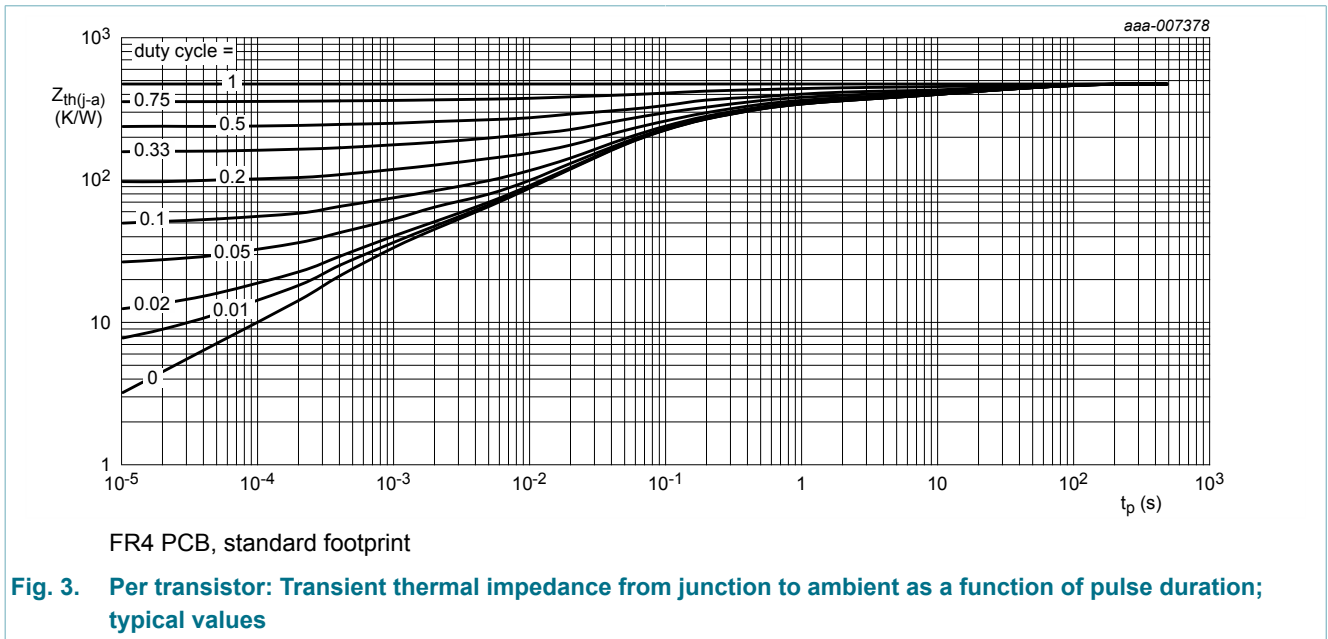
**Fig. 2. Per device: Power derating curve**

## 9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol                | Parameter                                   | Conditions  |     | Min | Typ | Max | Unit |
|-----------------------|---|-------------|-----|-----|-----|-----|------|
| <b>Per transistor</b> |   |             |     |     |     |     |      |
| $R_{th(j-a)}$         | thermal resistance from junction to ambient | in free air | [1] | -   | -   | 543 | K/W  |
| <b>Per device</b>     |   |             |     |     |     |     |      |
| $R_{th(j-a)}$         | thermal resistance from junction to ambient | in free air | [1] | -   | -   | 357 | K/W  |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.



## 10. Characteristics

Table 7. Characteristics

| Symbol   | Parameter                                     | Conditions  | Min | Typ  | Max | Unit          |            |
|--|---|---|-----|------|-----|---------------|------------|
| <b>Per transistor; for the PNP transistor with negative polarity</b> |   |   |     |      |     |               |            |
| $I_{CBO}$  | collector-base cut-off current (emitter open) | $V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}; T_{amb} = 25 \text{ }^\circ\text{C}$   | -   | -    | 100 | nA            |            |
| $I_{CEO}$  | collector-emitter cut-off current (base open) | $V_{CE} = 30 \text{ V}; I_B = 0 \text{ A}; T_{amb} = 25 \text{ }^\circ\text{C}$   | -   | -    | 1   | $\mu\text{A}$ |            |
|  |   | $V_{CE} = 30 \text{ V}; I_B = 0 \text{ A}; T_{amb} = 150 \text{ }^\circ\text{C}$  | -   | -    | 5   | $\mu\text{A}$ |            |
| $I_{EBO}$  | emitter-base cut-off current (collector open) | $V_{EB} = 5 \text{ V}; I_C = 0 \text{ A}; T_{amb} = 25 \text{ }^\circ\text{C}$  | -   | -    | 180 | $\mu\text{A}$ |            |
| $h_{FE}$   | DC current gain                               | $V_{CE} = 5 \text{ V}; I_C = 5 \text{ mA}; T_{amb} = 25 \text{ }^\circ\text{C}$   | 60  | -    | -   |               |            |
| $V_{CEsat}$  | collector-emitter saturation voltage          | $I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}; T_{amb} = 25 \text{ }^\circ\text{C}$  | -   | -    | 150 | mV            |            |
| $V_{I(off)}$   | off-state input voltage                       | $V_{CE} = 5 \text{ V}; I_C = 100 \text{ } \mu\text{A}; T_{amb} = 25 \text{ }^\circ\text{C}$                               | -   | 1.1  | 0.8 | V             |            |
| $V_{I(on)}$  | on-state input voltage                        | $V_{CE} = 0.3 \text{ V}; I_C = 5 \text{ mA}; T_{amb} = 25 \text{ }^\circ\text{C}$   | 2.5 | 1.7  | -   | V             |            |
| R1   | bias resistor 1                               | $T_{amb} = 25 \text{ }^\circ\text{C}$   | [1] | 15.4 | 22  | 28.6          | k $\Omega$ |
| R2/R1  | bias resistor ratio                           |   | [1] | 0.8  | 1   | 1.2           |            |
| $C_C$  | collector capacitance                         | $V_{CB} = 10 \text{ V}; I_E = 0 \text{ A}; f = 1 \text{ MHz}; T_{amb} = 25 \text{ }^\circ\text{C}; \text{TR1 (NPN)}$      | -   | -    | 2.5 | pF            |            |
|  |   | $V_{CB} = -10 \text{ V}; I_E = 0 \text{ A}; f = 1 \text{ MHz}; T_{amb} = 25 \text{ }^\circ\text{C}; \text{TR2 (PNP)}$     | -   | -    | 3   | pF            |            |
| $f_T$  | transition frequency                          | $V_{CE} = 5 \text{ V}; I_C = 10 \text{ mA}; f = 100 \text{ MHz}; T_{amb} = 25 \text{ }^\circ\text{C}; \text{TR1 (NPN)}$   | [2] | -    | 230 | -             | MHz        |
|  |   | $V_{CE} = -5 \text{ V}; I_C = -10 \text{ mA}; f = 100 \text{ MHz}; T_{amb} = 25 \text{ }^\circ\text{C}; \text{TR2 (PNP)}$ | [2] | -    | 180 | -             | MHz        |

[1] See section "Test information" for resistor calculation and test conditions.

[2] Characteristics of built-in transistor

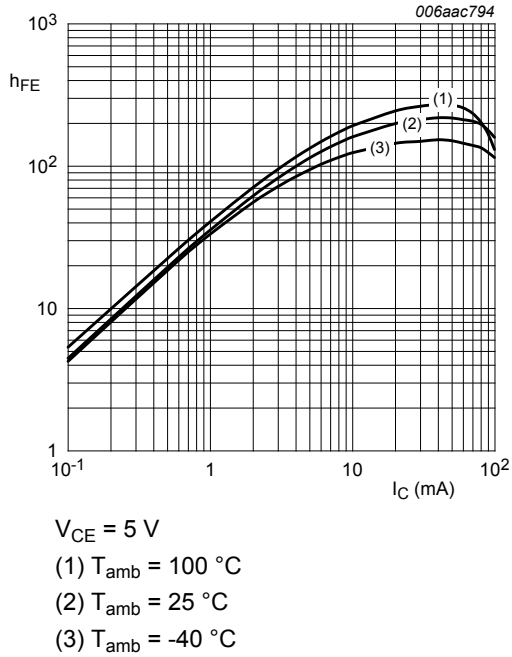


Fig. 4. NPN transistor: DC current gain as a function of collector current; typical values

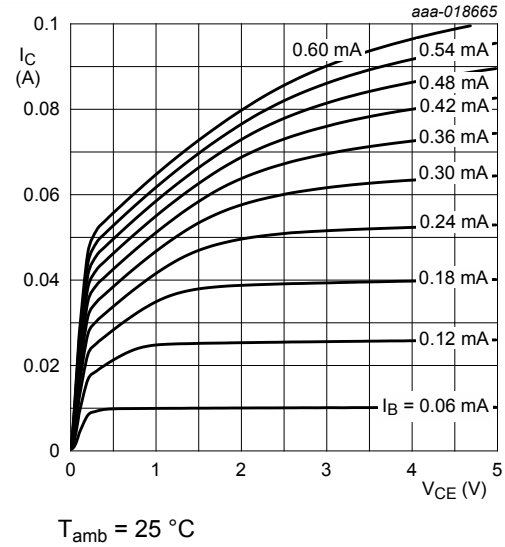


Fig. 5. NPN transistor: Collector current as a function of collector-emitter voltage; typical values

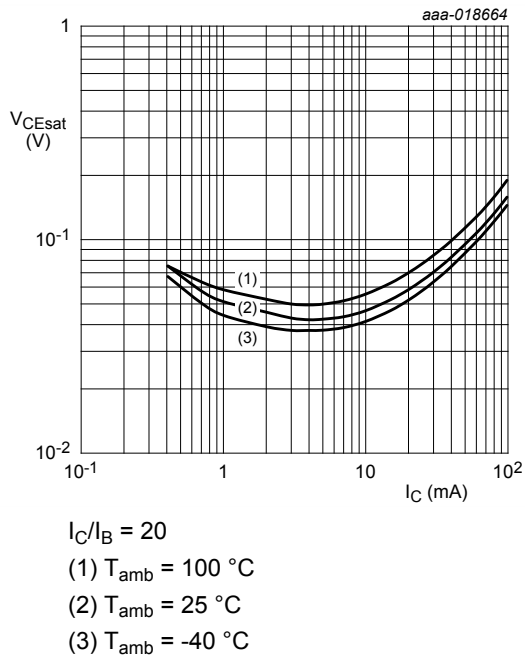


Fig. 6. NPN transistor: Collector-emitter saturation voltage as a function of collector current; typical values

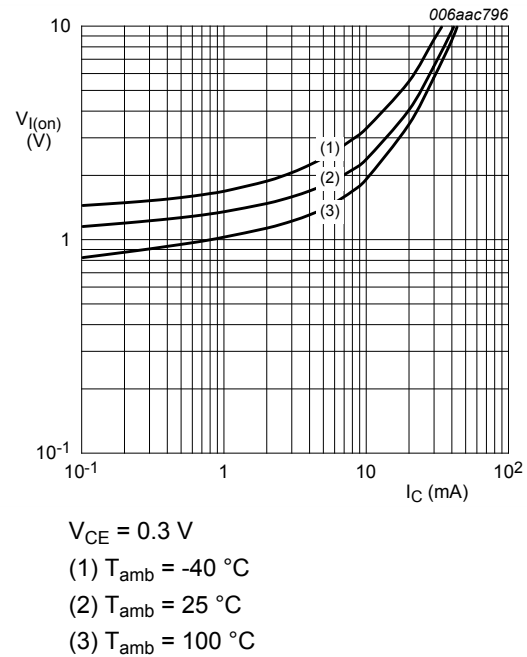
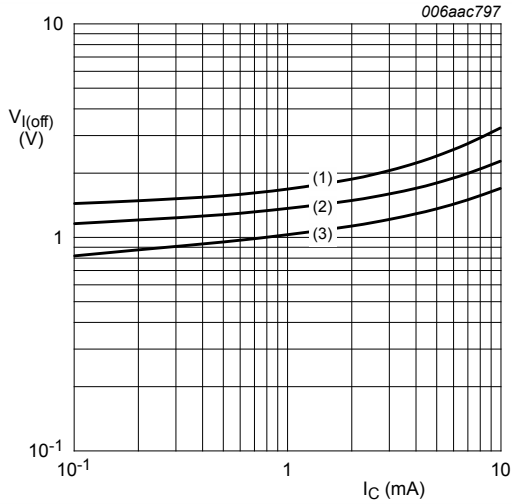
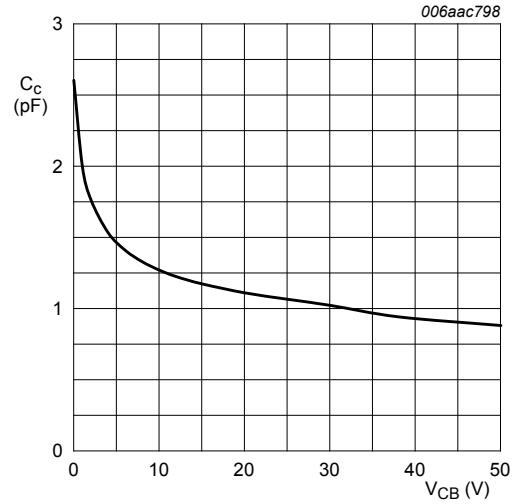


Fig. 7. NPN transistor: On-state input voltage as a function of collector current; typical values



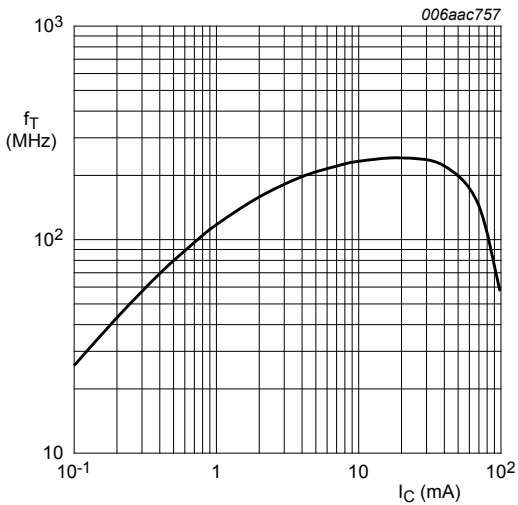
$V_{CE} = 5 \text{ V}$   
 (1)  $T_{amb} = -40 \text{ }^\circ\text{C}$   
 (2)  $T_{amb} = 25 \text{ }^\circ\text{C}$   
 (3)  $T_{amb} = 100 \text{ }^\circ\text{C}$

**Fig. 8. NPN transistor: Off-state input voltage as a function of collector current; typical values**



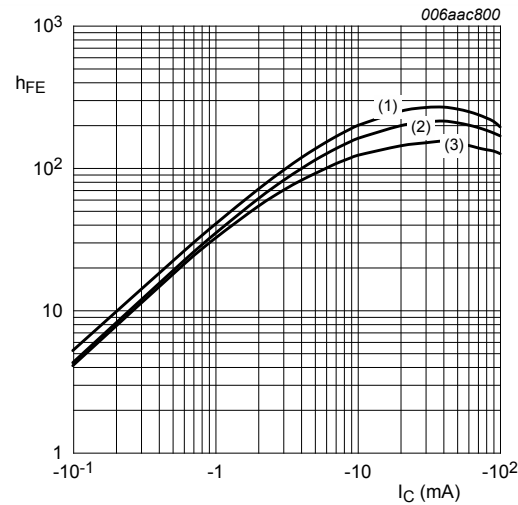
$f = 1 \text{ MHz}; T_{amb} = 25 \text{ }^\circ\text{C}$

**Fig. 9. NPN transistor: Collector capacitance as a function of collector-base voltage; typical values**



$V_{CE} = 5 \text{ V}; T_{amb} = 25 \text{ }^\circ\text{C}$

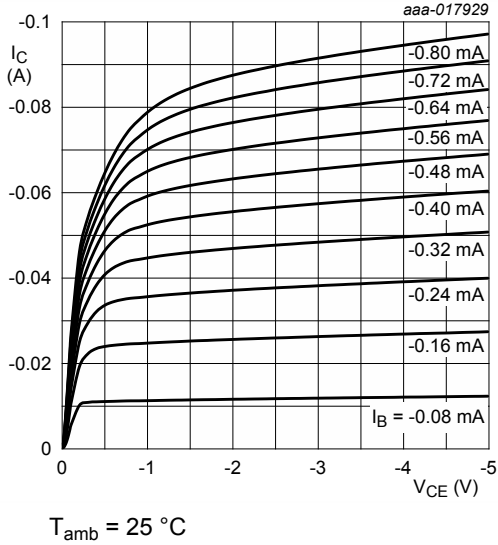
**Fig. 10. NPN transistor: Transition frequency as a function of collector current; typical values of built-in transistor**



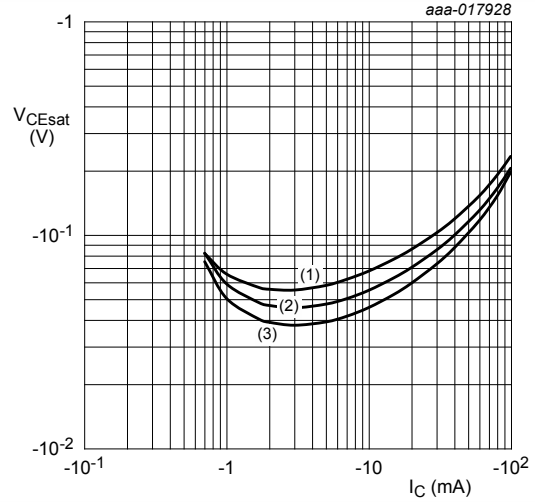
$V_{CE} = -5 \text{ V}$   
 (1)  $T_{amb} = 100 \text{ }^\circ\text{C}$   
 (2)  $T_{amb} = 25 \text{ }^\circ\text{C}$   
 (3)  $T_{amb} = -40 \text{ }^\circ\text{C}$

**Fig. 11. PNP transistor: DC current gain as a function of collector current; typical values**

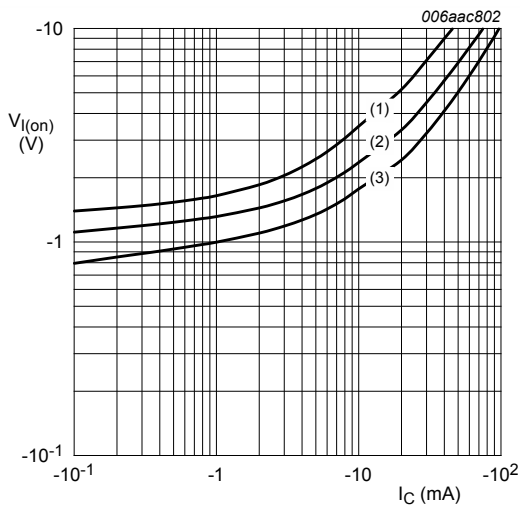




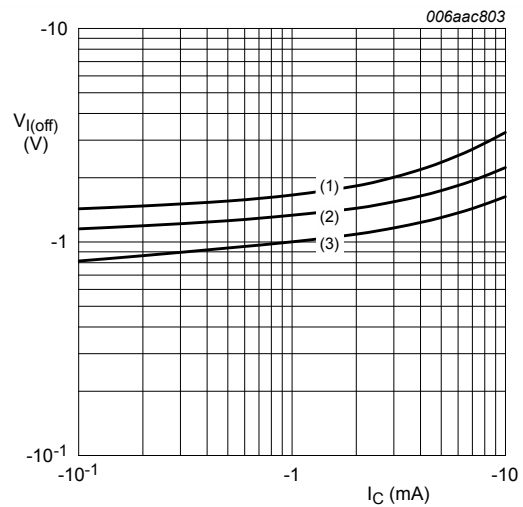
**Fig. 12. PNP transistor: Collector current as a function of collector-emitter voltage; typical values**



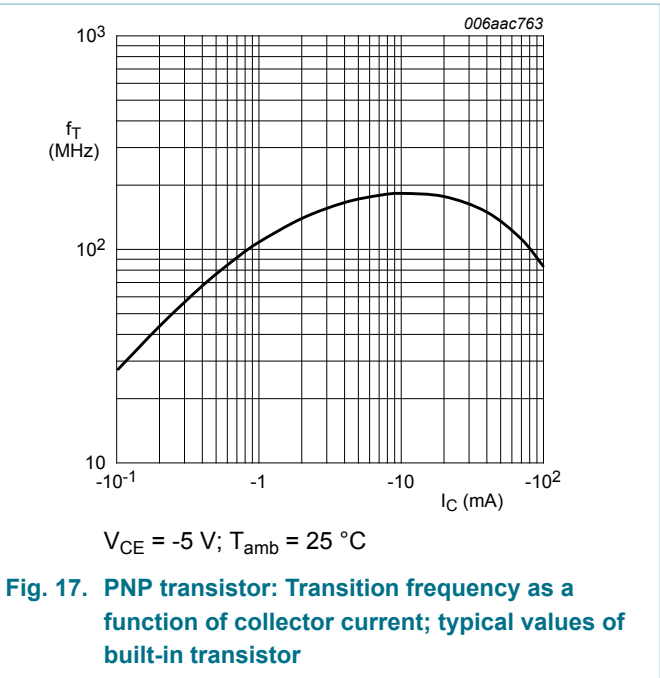
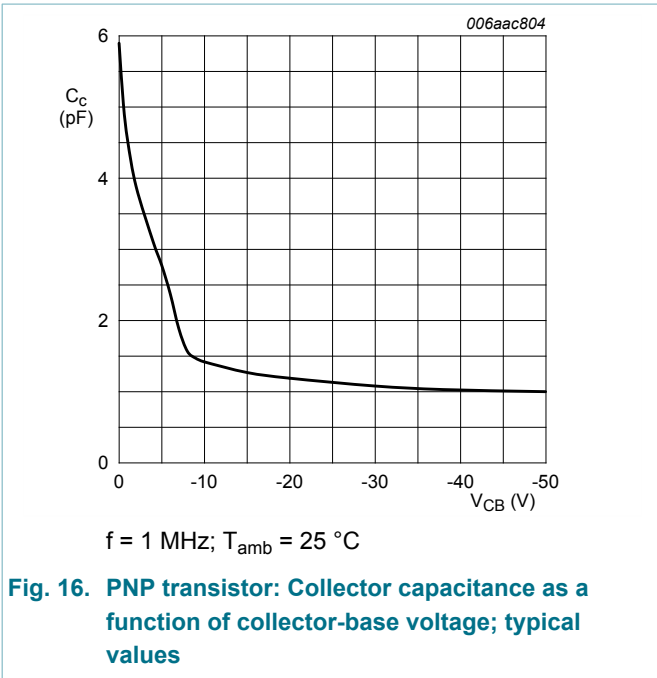
**Fig. 13. PNP transistor: Collector-emitter saturation voltage as a function of collector current; typical values**



**Fig. 14. PNP transistor: On-state input voltage as a function of collector current; typical values**



**Fig. 15. PNP transistor: Off-state input voltage as a function of collector current; typical values**



## 11. Test information

### 11.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

### 11.2 Resistor calculation

- Calculation of bias resistor 1 (R1)

$$R1 = \frac{V(I_{I2}) - V(I_{I1})}{I_{I2} - I_{I1}}$$

- Calculation of bias resistor ratio (R2/R1)

$$\frac{R2}{R1} = \frac{V(I_{I4}) - V(I_{I3})}{R1 \cdot (I_{I4} - I_{I3})} - 1$$

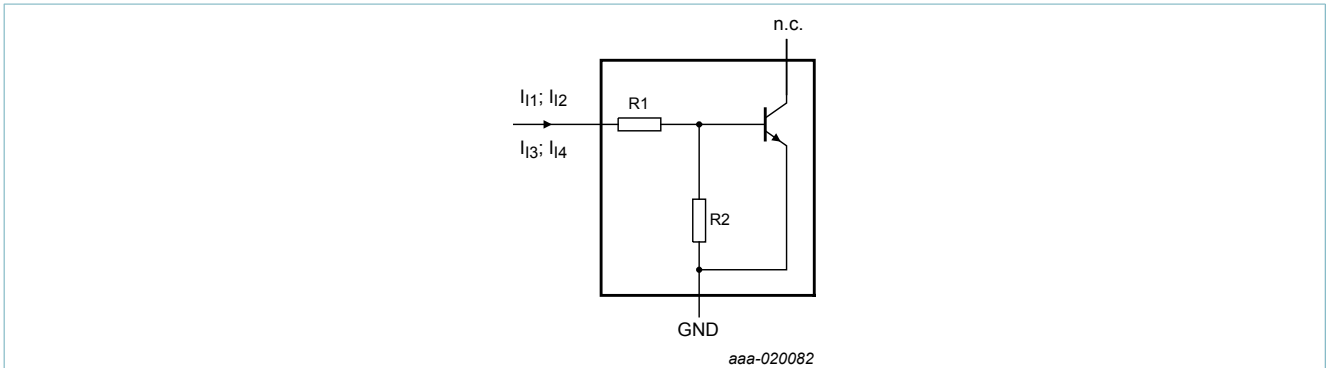


Fig. 18. NPN transistor: Resistor test circuit

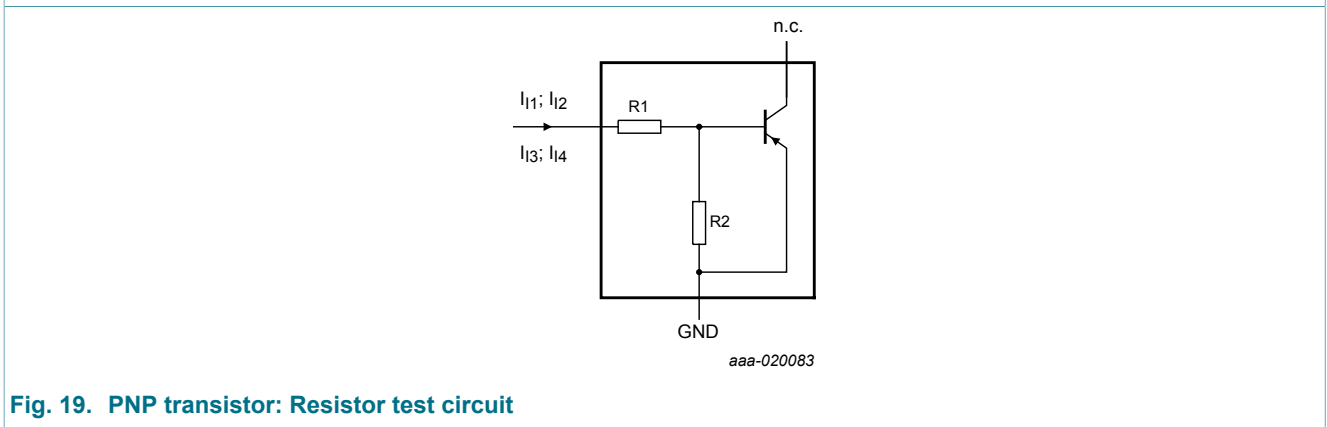


Fig. 19. PNP transistor: Resistor test circuit

### 11.3 Resistor test conditions

Table 8. Resistor test conditions

Per transistor; for the PNP transistor with negative polarity

| R1 (kΩ) | R2 (kΩ) | Test conditions |                 |                 |                 |
|---------|---------|-----------------|-----------------|-----------------|-----------------|
|         |         | I <sub>11</sub> | I <sub>12</sub> | I <sub>13</sub> | I <sub>14</sub> |
| 22      | 22      | 150 μA          | 230 μA          | -150 μA         | -230 μA         |

## 12. Package outline

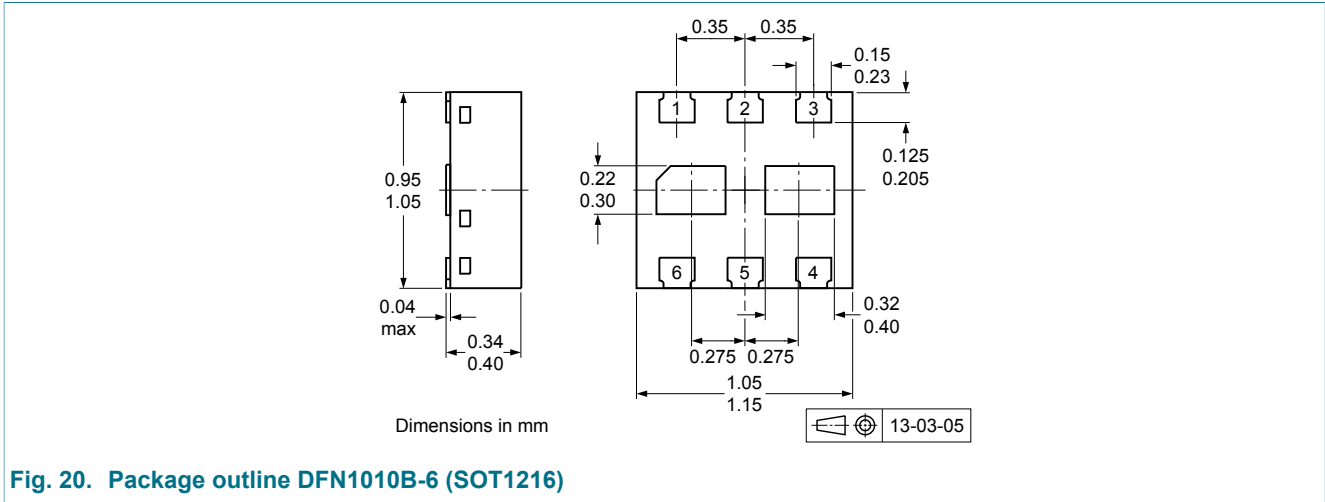


Fig. 20. Package outline DFN1010B-6 (SOT1216)

### 13. Soldering

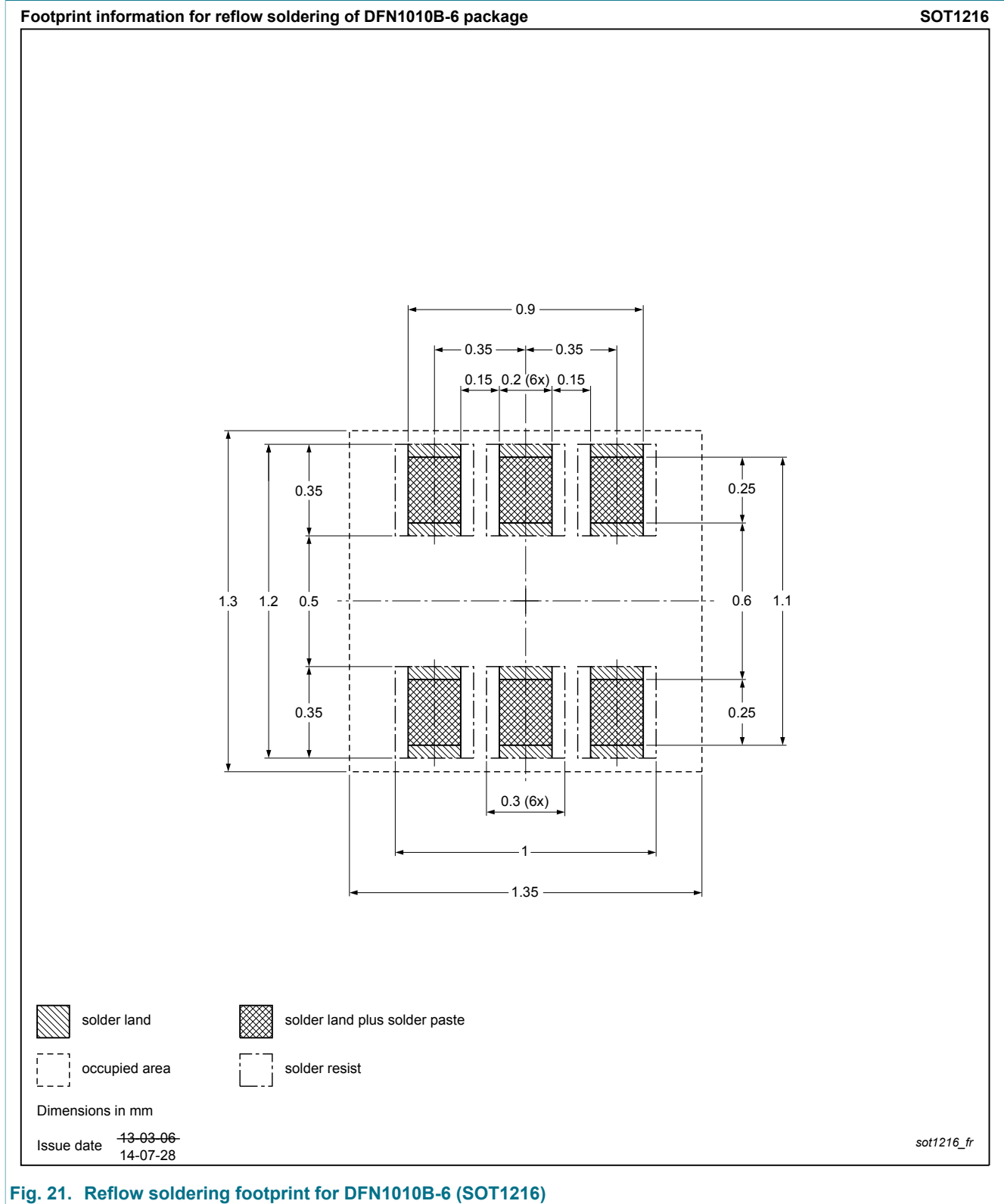


Fig. 21. Reflow soldering footprint for DFN1010B-6 (SOT1216)

## 14. Revision history

Table 9. Revision history

| Data sheet ID | Release date | Data sheet status  | Change notice | Supersedes |
|---------------|--------------|--------------------|---------------|------------|
| PQMD2 v.1     | 20151104     | Product data sheet | -             | -          |

## 15. Legal information

### 15.1 Data sheet status

| Document status [1][2]         | Product status [3] | Definition  |
|--------------------------------|--------------------|---|
| Objective [short] data sheet   | Development        | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification      | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production         | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

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## 16. Contents

|           |                                      |           |
|-----------|--------------------------------------|-----------|
| <b>1</b>  | <b>General description .....</b>     | <b>1</b>  |
| <b>2</b>  | <b>Features and benefits .....</b>   | <b>1</b>  |
| <b>3</b>  | <b>Applications .....</b>            | <b>1</b>  |
| <b>4</b>  | <b>Quick reference data .....</b>    | <b>1</b>  |
| <b>5</b>  | <b>Pinning information .....</b>     | <b>2</b>  |
| <b>6</b>  | <b>Ordering information .....</b>    | <b>2</b>  |
| <b>7</b>  | <b>Marking .....</b>                 | <b>3</b>  |
| <b>8</b>  | <b>Limiting values .....</b>         | <b>4</b>  |
| <b>9</b>  | <b>Thermal characteristics .....</b> | <b>5</b>  |
| <b>10</b> | <b>Characteristics .....</b>         | <b>6</b>  |
| <b>11</b> | <b>Test information .....</b>        | <b>10</b> |
| 11.1      | Quality information .....            | 10        |
| 11.2      | Resistor calculation .....           | 10        |
| 11.3      | Resistor test conditions .....       | 11        |
| <b>12</b> | <b>Package outline .....</b>         | <b>12</b> |
| <b>13</b> | <b>Soldering .....</b>               | <b>13</b> |
| <b>14</b> | <b>Revision history .....</b>        | <b>14</b> |
| <b>15</b> | <b>Legal information .....</b>       | <b>15</b> |
| 15.1      | Data sheet status .....              | 15        |
| 15.2      | Definitions .....                    | 15        |
| 15.3      | Disclaimers .....                    | 15        |
| 15.4      | Trademarks .....                     | 16        |

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